

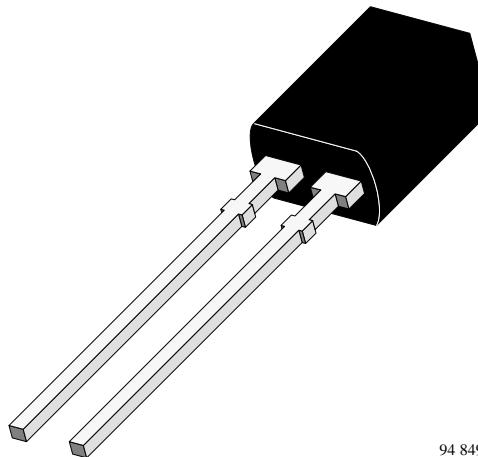
Silicon PIN Photodiode

Description

S186P is a high speed and high sensitive PIN photodiode in a flat side view plastic package.

The epoxy package itself is an IR filter, spectrally matched to GaAs or GaAs on GaAlAs IR emitters ($\lambda_p \geq 900$ nm).

The large active area combined with a flat case gives a high sensitivity at a wide viewing angle



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Features

- Fast response times
- Small junction capacitance
- High radiant sensitivity
- Large radiant sensitive area $A=7.5\text{ mm}^2$
- Wide angle of half sensitivity $\varphi = \pm 65^\circ$
- Plastic case with IR filter (950 nm)
- Suitable for near infrared radiation

Applications

High speed photo detector

Absolute Maximum Ratings $T_{amb} = 25^\circ C$

Parameter	Test Conditions	Symbol	Value	Unit
Reverse Voltage		V_R	60	V
Power Dissipation	$T_{amb} \leq 25^\circ C$	P_V	215	mW
Junction Temperature		T_j	100	$^\circ C$
Storage Temperature Range		T_{stg}	-55...+100	$^\circ C$
Soldering Temperature	$t \leq 5$ s	T_{sd}	260	$^\circ C$
Thermal Resistance Junction/Ambient		R_{thJA}	350	K/W

Basic Characteristics $T_{amb} = 25^\circ C$

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Breakdown Voltage	$I_R = 100 \mu A, E = 0$	$V_{(BR)}$	60			V
Reverse Dark Current	$V_R = 10 V, E = 0$	I_{ro}		2	30	nA
Diode Capacitance	$V_R = 0 V, f = 1 MHz, E = 0$	C_D		70		pF
Diode Capacitance	$V_R = 3 V, f = 1 MHz, E = 0$	C_D		25	40	pF
Open Circuit Voltage	$E_e = 1 mW/cm^2, \lambda = 950 nm$	V_o		350		mV
Short Circuit Current	$E_e = 1 mW/cm^2, \lambda = 950 nm$	I_k		38		μA
Reverse Light Current	$E_e = 1 mW/cm^2, \lambda = 950 nm, V_R = 5 V$	I_{ra}	43	45		μA
Angle of Half Sensitivity		ϕ		± 65		deg
Wavelength of Peak Sensitivity		λ_p		950		nm
Range of Spectral Bandwidth		$\lambda_{0.5}$		870...1050		nm
Noise Equivalent Power	$V_R=20V, \lambda=950nm$	NEP		4×10^{-14}		W/\sqrt{Hz}
Rise Time	$V_R=10V, R_L=1k\Omega, \lambda=820nm$	t_r		100		ns
Fall Time	$V_R=10V, R_L=1k\Omega, \lambda=820nm$	t_f		100		ns

Typical Characteristics ($T_{amb} = 25^\circ C$ unless otherwise specified)

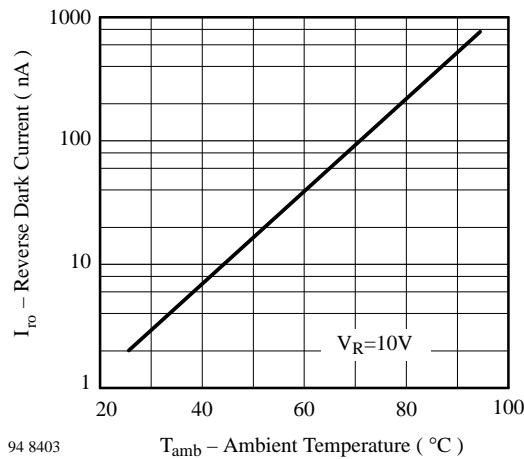


Figure 1 : Reverse Dark Current vs. Ambient Temperature

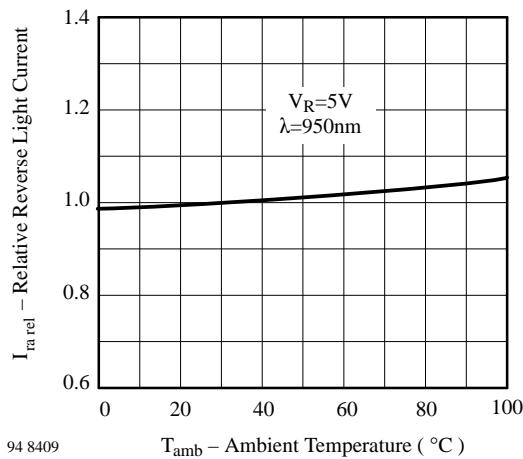


Figure 2 : Relative Reverse Light Current vs. Ambient Temperature

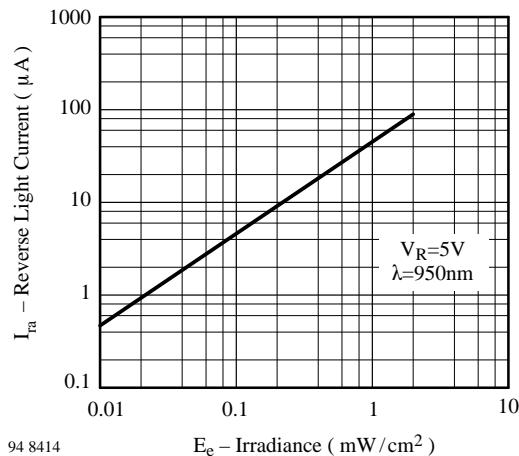


Figure 3 : Reverse Light Current vs. Irradiance

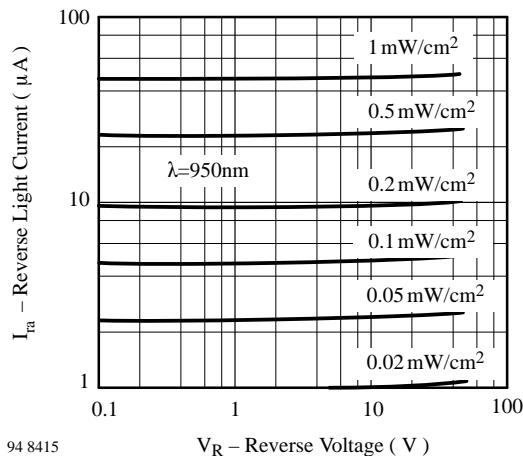


Figure 4 : Reverse Light Current vs. Reverse Voltage

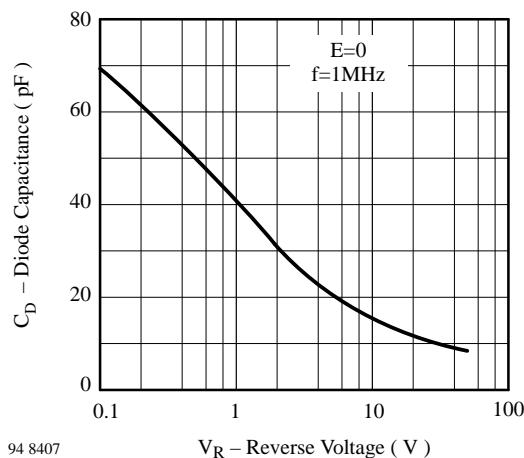


Figure 5 : Diode Capacitance vs. Reverse Voltage

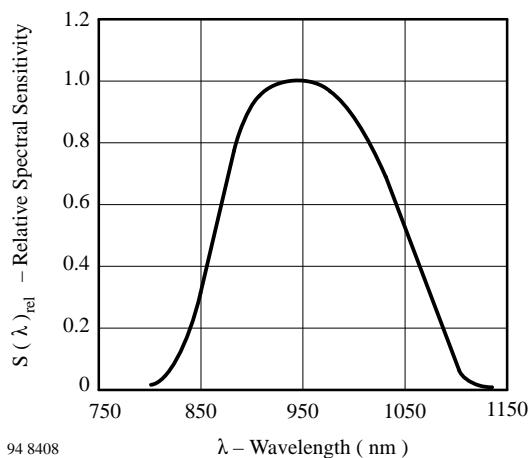
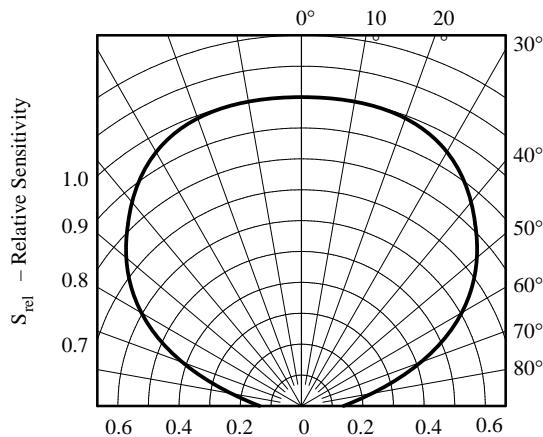


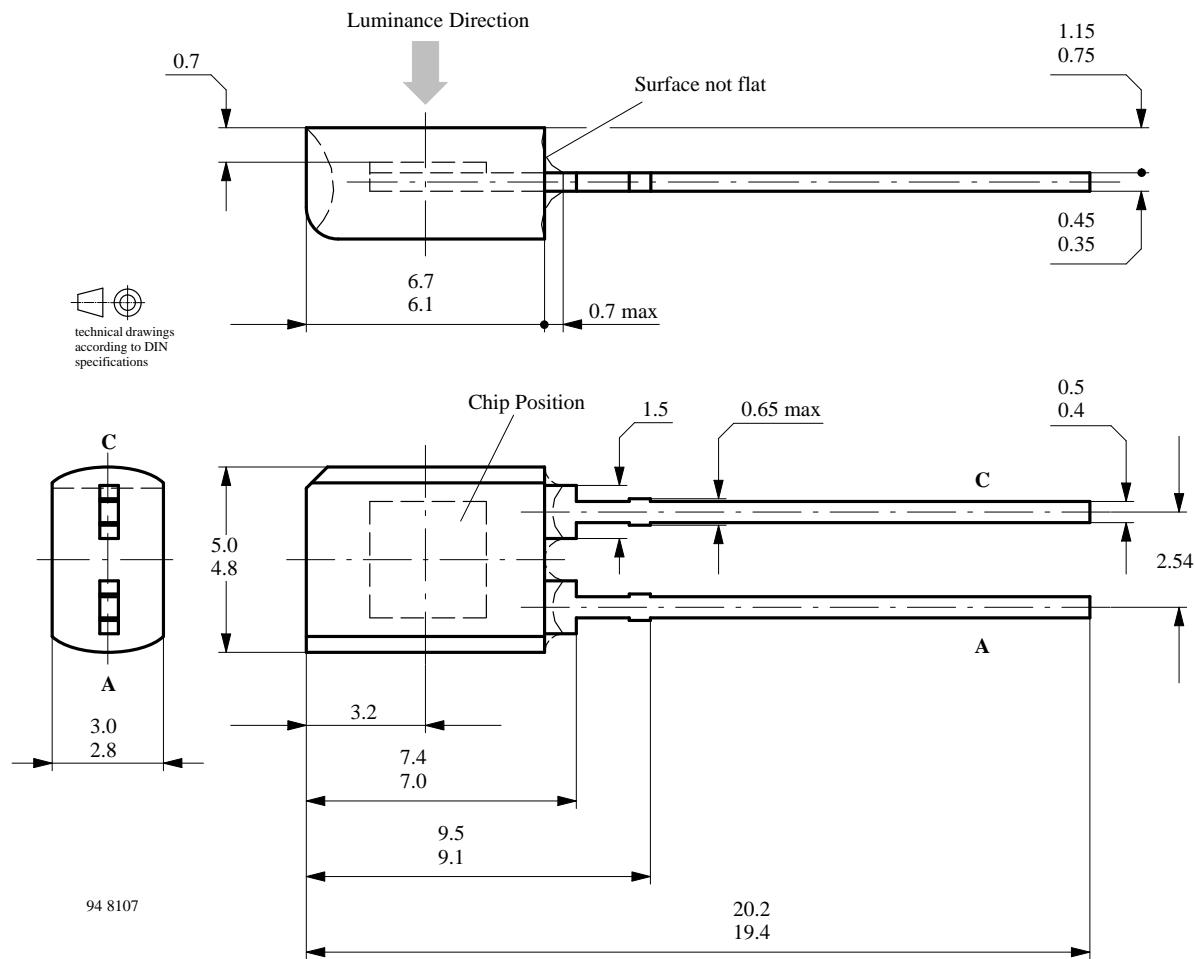
Figure 6 : Relative Spectral Sensitivity vs. Wavelength



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Figure 7 : Relative Radiant Sensitivity vs. Angular Displacement

Dimensions in mm



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